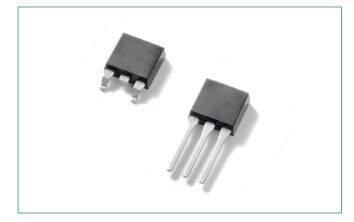
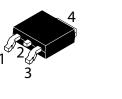
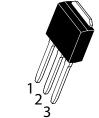


MCR70xA Series



Pin Out





Description

PNPN Componants designed for high volume, low cost consumer applications such as temperature, light and speed control; process and remote control; and warning systems where reliability of operation is critical.

Features

- Small Size
- Passivated Die Surface for Reliability and Uniformity
- Low Level Triggering and Holding Characteristics
- Recommend Electrical Replacement for C106
- Surface Mount Package Case 369C
- To Obtain "DPAK" in Straight Lead Version (Shipped in Sleeves): Add '1' Suffix to Componant Number, i.e., MCR706A1
- UL Recognized compound meeting flammability rating V-0.

Po

- ESD Ratings: Human Body Model, 3B > 8000 V Machine Model, C > 400 V
- Pb–Free Packages are Available

Additional Information

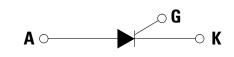






Samples

Functional Diagram



Thyristors Surface Mount – 100V -600V > MCR70xA Series

Maximum Ratings (T = 25°C unless otherwise noted)

Rating		Symbol	Value	Unit
Peak Repetitive Off-State Voltage (Note 1) (T_c = - 40 to +110°C, Sine Wave, 50 to 60 Hz, R_{_{GK}} = 1 k Ω)	MCR703A MCR706A MCR708A	V _{drm} , V _{rrm}	100 400 600	V
Peak Non-Repetitive Off–State Voltage (180° Conduction Angles; $T_c = 85^{\circ}$ C)	MCR703A MCR706A MCR708A	V _{DSM}	150 450 650	V
On–State RMS Current (180° Conduction Angles; $T_c = 90$ °C)		I _{T(RMS)}	4.0	A
Average On-State Current (180° Conduction Angles)	$T_c = -40 \text{ to } +90^{\circ}\text{C}$ $T_c = +100^{\circ}\text{C}$	I _{T(AV)}	2.6 1.6	А
Non-Repetitive Surge Current (1/2 Cycle, Sine Wave 60 Hz, $T_J = 110^{\circ}$ C) (1/2 Cycle, Sine Wave 1.5 ms, $T_J = 110^{\circ}$ C)		I _{tsm}	25 35	А
Circuit Fusing Consideration (t = 8.3 ms)		l²t	2.6	A ² sec
Forward Peak Gate Power (Pulse Width \leq 1.0 $\mu sec, T_c = 90^{\circ} \text{C})$		P _{GM}	0.5	W
Forward Peak Gate Current (Pulse Width \leq 1.0 $\mu sec, T_c =$ 90°C)		I _{GM}	0.2	A
Forward Average Gate Power (t = $8.3 \text{ ms}, \text{TC} = 90^{\circ}\text{C}$)		P _{G(AV)}	0.1	W
Operating Junction Temperature Range		TJ	-40 to +110	°C
Storage Temperature Range		T _{stg}	-40 to +150	°C

Stresses exceeding Maximum Ratings may damage the Componant. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect Componant reliability.

L V_{DIM} and V_{BML} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the Componants are exceeded.

Thermal Characteristics*						
Rating	Symbol	Value	Unit			
Thermal Resistance, Junction-to-Case	R _{ejc}	3.0	°C/W			
Thermal Resistance, Junction-to-Ambient (Note 2)	R _{eja}	80	C/VV			
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	TL	260	°C			

2. Case 369C when surface mounted on minimum pad sizes recommended.

Electrical Characteristics - OFF (T₁ = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
Peak Repetitive Forward or Reverse Blocking Current (V_{AK} = Rated V_{DRM} or $V_{RRM'}$ R _{GK} = 1 k Ω)	T _J = 25°C T _J = 110°C	I DRM I _{RRM}	-	-	10 200	μΑ

Electrical Characteristics - **ON** ($T_J = 25^{\circ}C$ unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
Peak Forward "On" Voltage (I_{TM} = 8.2 A Peak, Pulse Width = 1 to 2 ms, 2% Duty Cycle)		V _{TM}	-	-	2.2	V
	= 25°C = -40°C	I _{gt}	-	25 -	75 300	μΑ
$ \begin{array}{l} \mbox{Gate Trigger Voltage (Continuous dc) (Note 3)} & T_{\rm J} \\ \mbox{(V}_{\rm AK} = 12 \mbox{ V; R}_{\rm L} = 24 \ \Omega) & T_{\rm J} \end{array} $	= 25°C = -40°C	V _{gt}	-	-	0.8 1.0	V
Gate Non-Trigger Voltage (Note 3) (V _{AK} = 12 Vdc; R _L = 100 Ω , T _C =110°)		V_{gD}	0.2	-	_	V
Holding Current ($V_{AK} = 12 \text{ Vdc}, R_{GK} = 1 \text{ k } \Omega$) $T_{C} = 25^{\circ}\text{C}$ (Initiating Current = 20 mA) $T_{C} = -40^{\circ}\text{C}$		I _H	-		5.0 10	mA
Peak Reverse Gate Blocking Voltage ($I_{gR} = 10 \ \mu A$)		V _{RGM}	10	12.5	18	V
Peak Reverse Gate Blocking Current (V_{gR} = 10 V)		I _{rgm}	-	-	1.2	μA
Total Turn-On Time (Source Voltage = 12 V, RS = 6 kQ) (I _{TM} = 8.2 A, I _{GT} = 2 mA, Rated V _{DRM}) (Rise Time = 20 ns, Pulse Width = 10 μ s)		t _{gt}	-	2.0	-	μs



Thyristors Surface Mount – 100V -600V > MCR70xA Series

Dynamic Characteristics*						
Characteristic	Symbol	Min	Тур	Мах	Unit	
Critical Rate of Rise of Off–State Voltage ($V_{_D}$ = Rated $V_{_{DRM'}}$ R _{GK} = 1 k Ω , Exponential Waveform, Gate Open, T _c = 110°C)	dv/dt	-	10	-	V/µs	
Repetitive Critical Rate of Rise of On–State Current (Cf = 60 Hz, I_{PK} = 30 A, PW = 100 µs, diG/dt = 1 A/µs)	di/dt	-	_	100	A/µs	

3. RGK current not included in measurement.

Voltage Current Characteristic of SCR

Symbol	Parameter
V _{DRM}	Peak Repetitive Forward Off State Voltage
I _{DRM}	Peak Forward Blocking Current
V _{BBM}	Peak Repetitive Reverse Off State Voltage
I _{BBM}	Peak Reverse Blocking Current
V _{TM}	Maximum On State Voltage
I _H	Holding Current

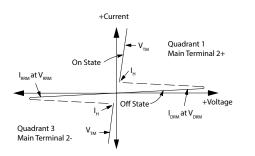
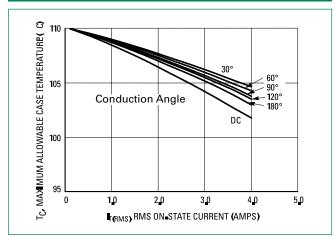


Figure 1. RMS Current Derating





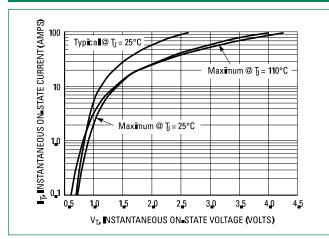


Figure 2. On–State Power Dissipation

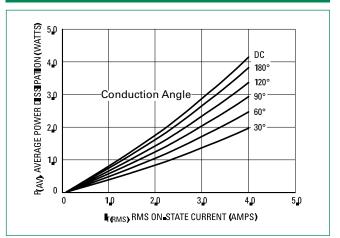
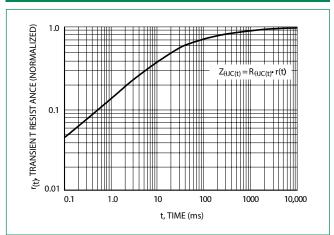


Figure 4. Transient Thermal Response



^{© 2020} Littelfuse, Inc. Specifications are subject to change without notice. Revised: B0.11/17/20



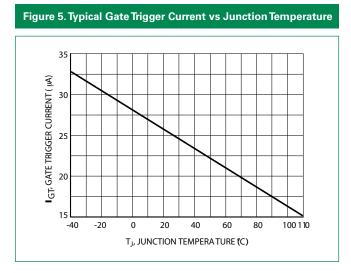


Figure 7. Typical Holding Current vs Junction Temperature

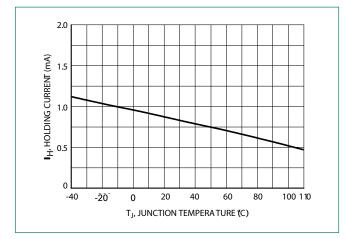


Figure 6. Typical Gate Trigger Voltage vs Junction Temperature

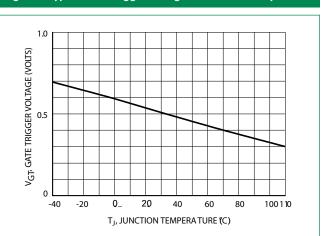
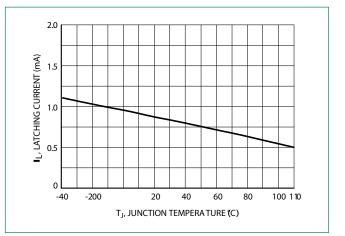
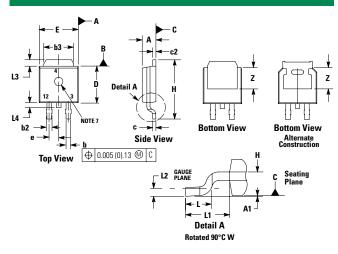


Figure 8. Typical Latching Current vs Junction Temperature



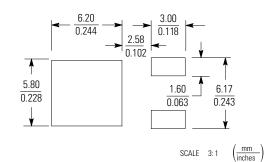


Dimensions



Inches

Soldering Footprint



Dim	Min	Мах	Min	Max	
Α	0.087	0.094	2.20	2.40	
A1	0.000	0.005	0.00	0.12	
b	0.022	0.030	0.55	0.75	
b2	0.026	0.033	0.65	0.85	
b3	0.209	0.217	5.30	5.50	
C	0.019	0.023	0.49	0.59	
c2	0.019	0.023	0.49	0.59	
D	0.213	0.224	5.40	5.70	
Е	0.252	0.260	6.40	6.60	
е	0.0	91	2.30		
н	0.374	0.406	9.50	10.30	
L	0.058	0.070	1.47	1.78	
L1	0.1	14	2.	90	
L2	0.019	0.023	0.49	0.59	
L3	0.053	0.065	1.35	1.65	
L4	0.028	0.039	0.70	1.00	
Z	0.154	-	3.90	-	

Millimeters

Dimensioning and Tolerancing per ANSI Y14.5M, 1982.
Controlling Dimension: Inch.

STYLE 6:PIN 1. GATE2. ANODE3. CATHODE4. ANODE

© 2020 Littelfuse, Inc. Specifications are subject to change without notice. Revised: B0.11/17/20